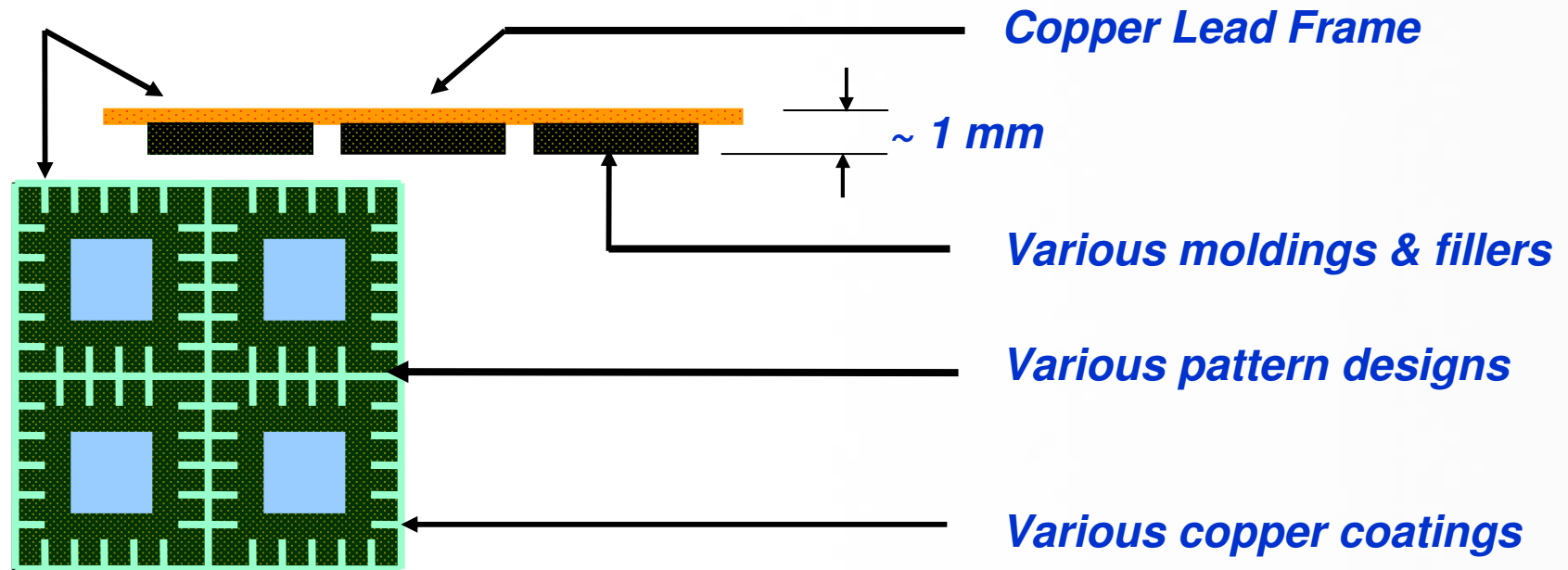


QFN SINGULATION

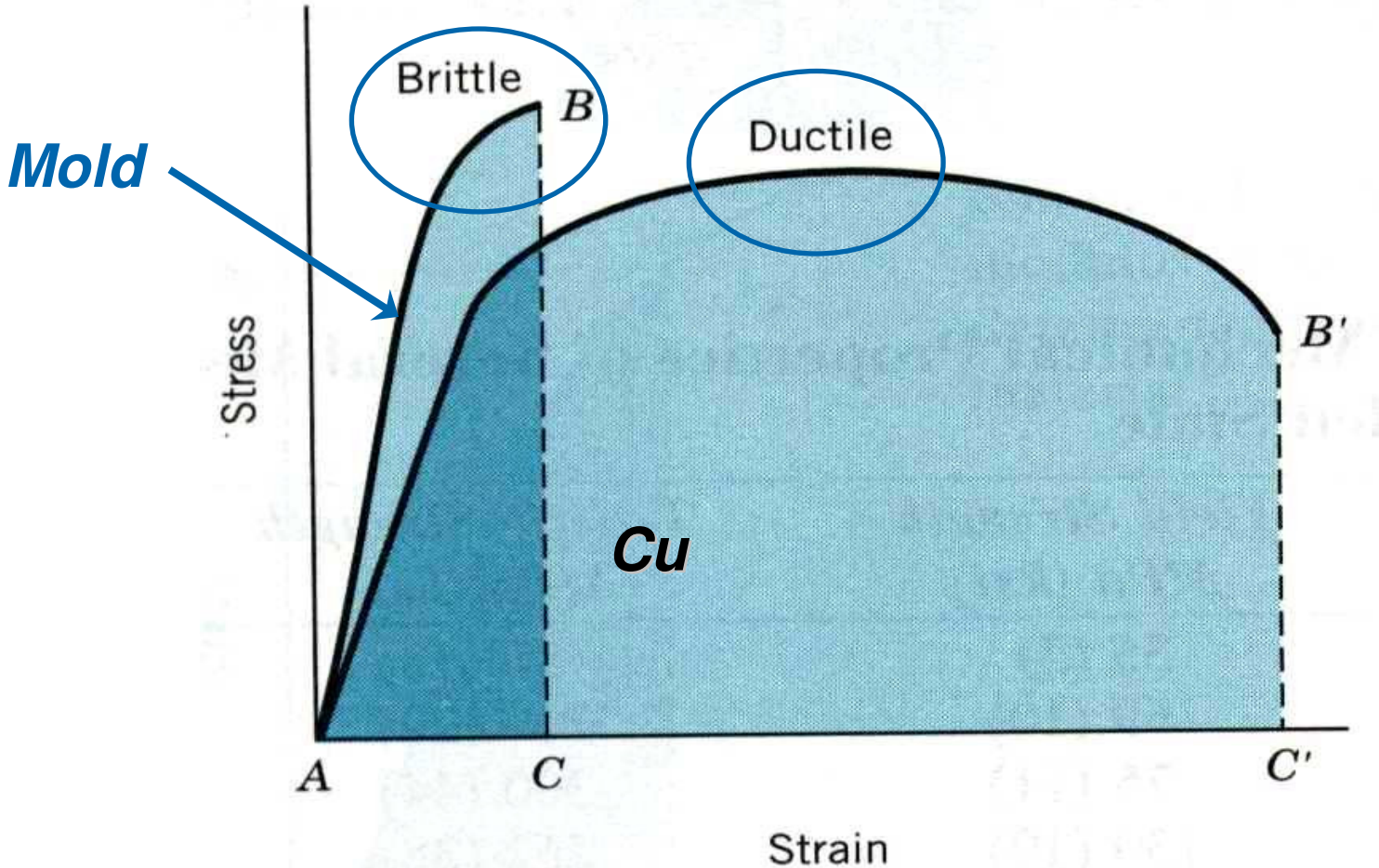
- **Package foundries are demanding process solutions to reduce Cost of Ownership, while maintaining product Quality**

QFN Singulation



Composite Materials

QFN Singulation



Plastic Deformation

QFN Families

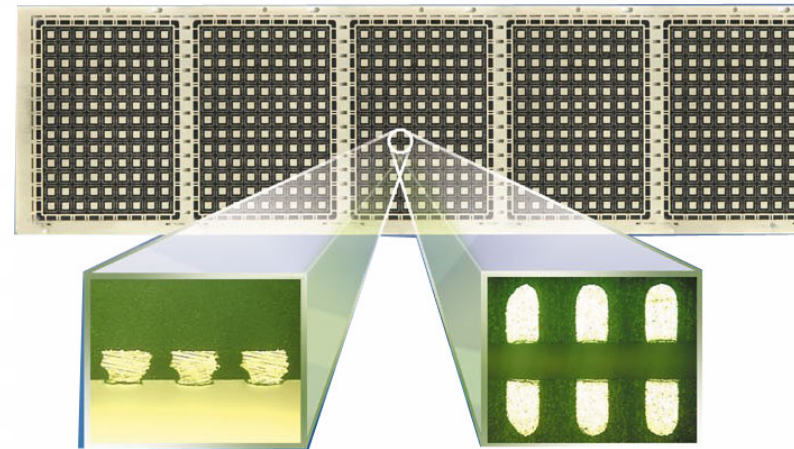
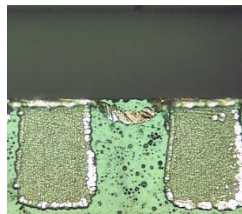
Three main family types:

- Power - Largest thickness 1.5-2.5mm (~ 500 mic. copper lead thickness)
- Standard - HE 0.8-1.2mm (up to 200 mic. copper lead thickness)
- Thin – 0.4- 0.6mm (up to 150 mic. copper lead thickness)

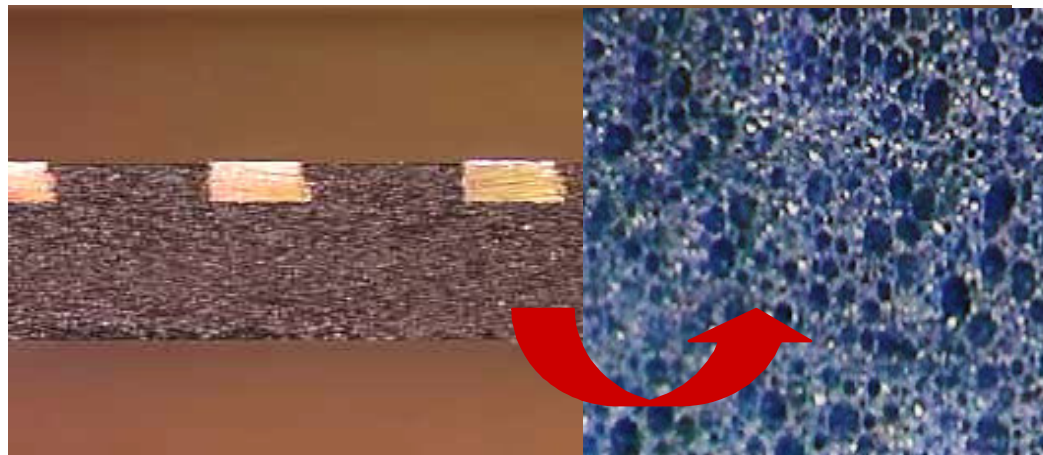
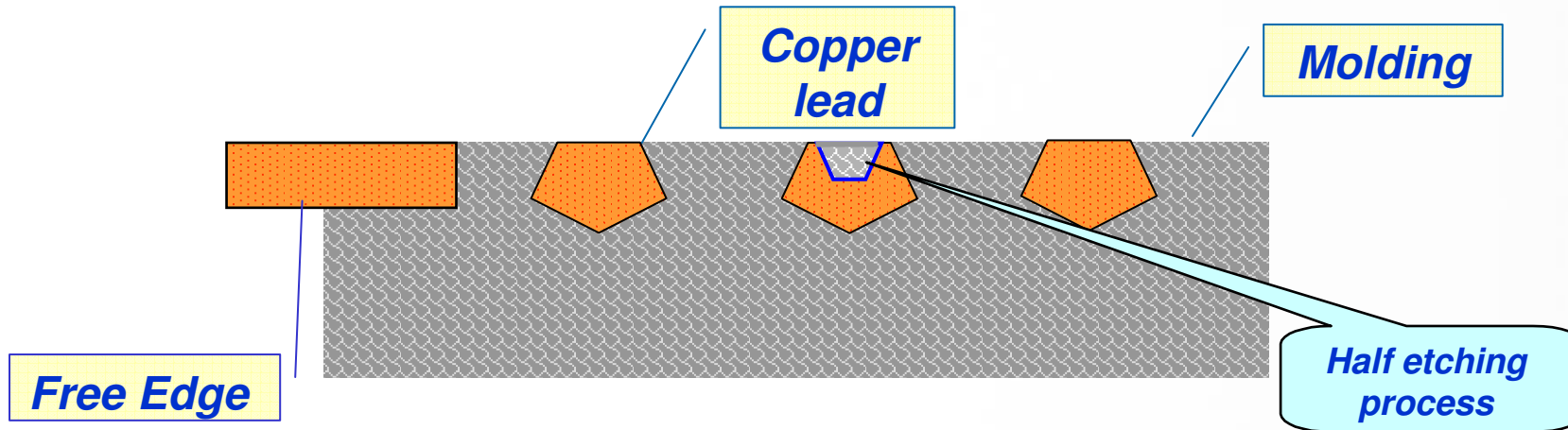
Two different Types of Coating:

- Tin (Sn) – causing melting
- Ni/Pd – larger “Y” burrs

SN coating melting



QFN Singulation



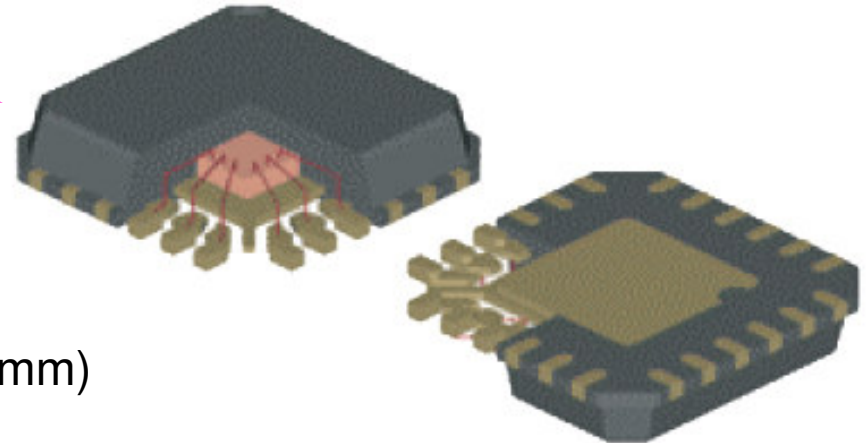
Composite material

QFN - Blade and Cutting Parameters

-Blade Characteristics

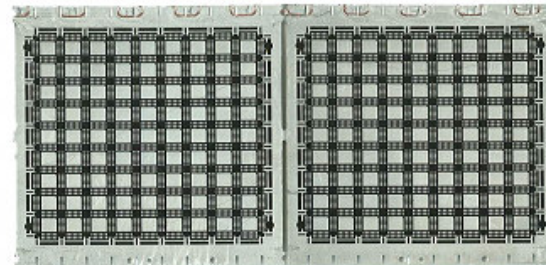


- 2" - 3" - 4" Resinoid types "E" & "T"
- Diamond grit size: 45 - 105 microns
- Thickness: .008" - .020" (0.2mm - 0.5mm)



-Cutting Parameters

- Feed rate:
 - ❑ Half Etched: 30 - 100 mm/sec
 - ❑ Full Copper: 10 - 40 mm/sec
- Spindle speed:
 - ❑ 2": 25-30 krpm
 - ❑ 3": 15-25 krpm

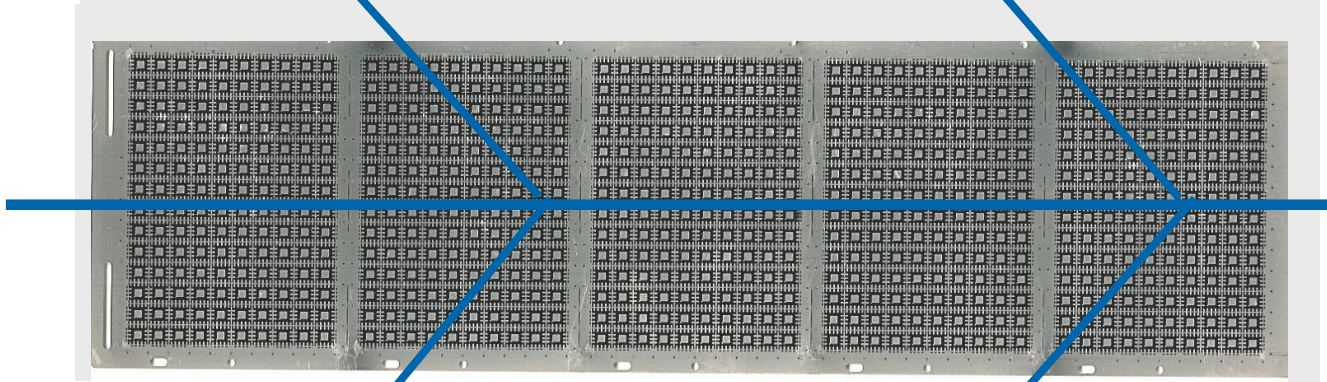


QFN Singulation

Substrate matrix

Throughput

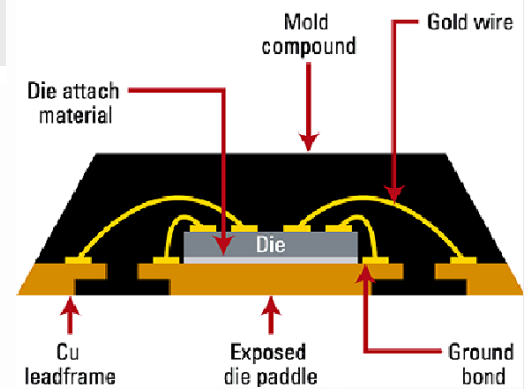
Molding
Feed rate
Copper



QFN/MLP SINGULATION

MICROLEADFRAME PACKAGE

De-lamination
Burrs
Melting on Sn
Chipping
Smearing
Quality
Life
Blade



Factors affecting the cutting results



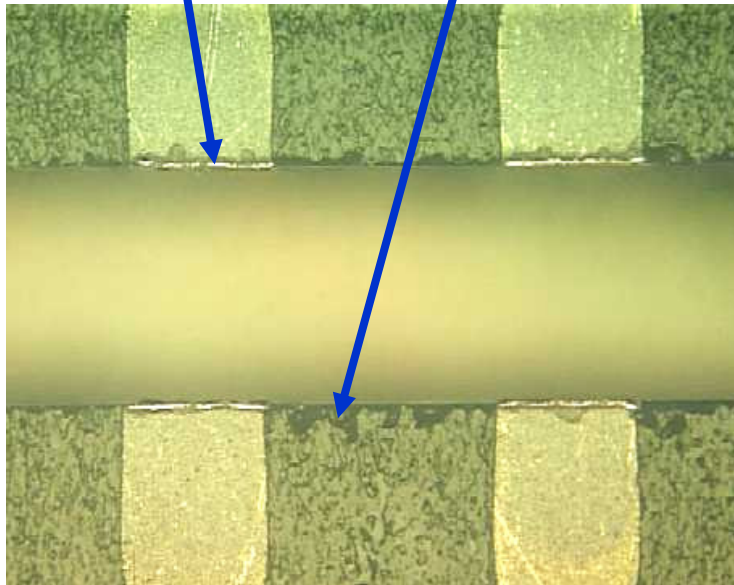
QFN Singulation

<u>Characteristic</u>	<u>Current Status</u>
<i>Blade life</i>	<i>500 - 1500 meter</i>
<i>Feed rate</i>	<i>30 – 100 mm/sec</i>
<i>Coolant</i>	<i>D.I. & Additive & Chiller</i>

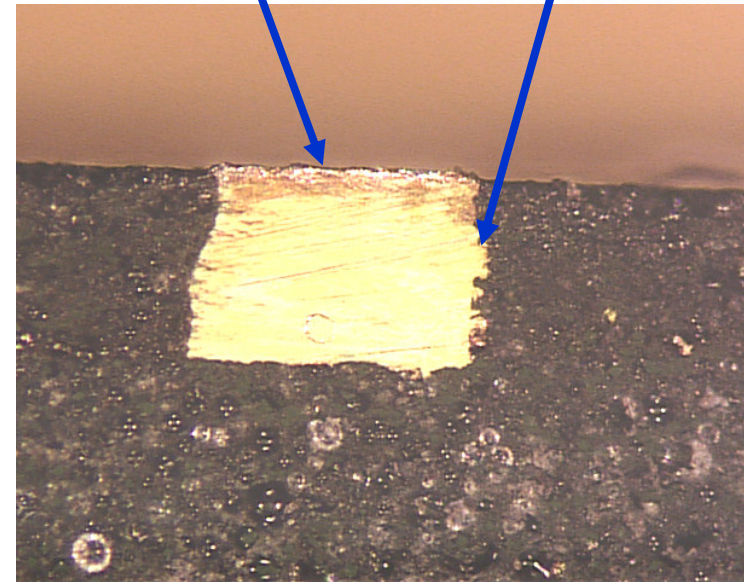
Market Status

QFN Singulation

Side Burrs **Molding Chipping**

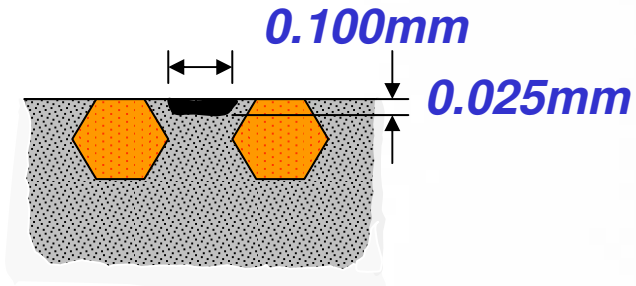


Top Burrs **Smearing**

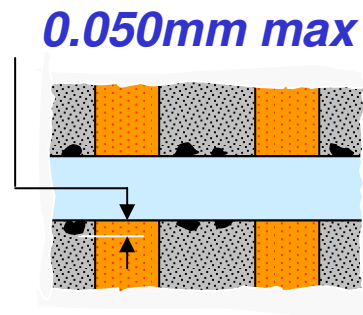


Quality Criteria

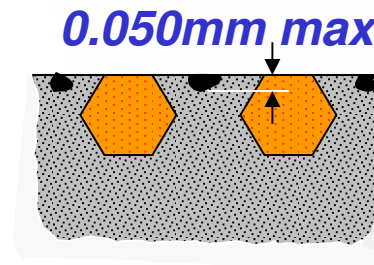
QFN Singulation



Continuous chipping



Top view

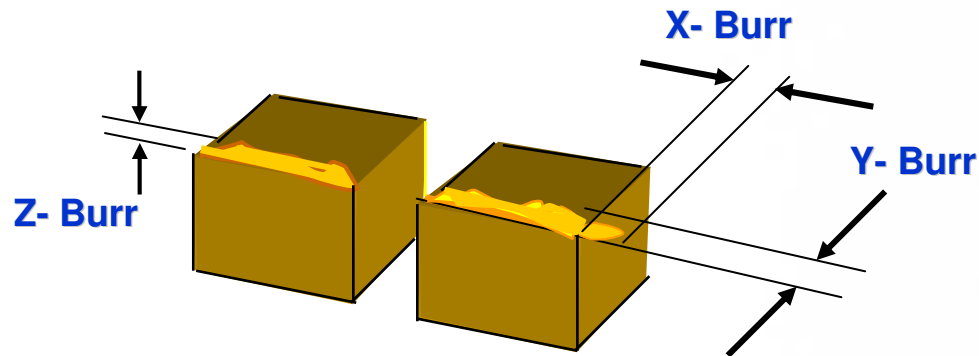


Cross section

❖ *Specification limits may vary between end-users*

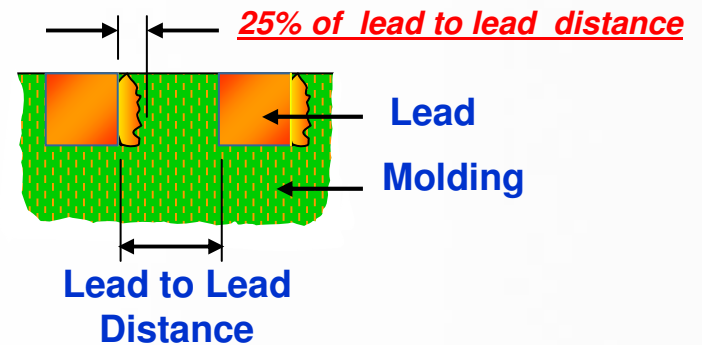
Chipping Specification

QFN Singulation



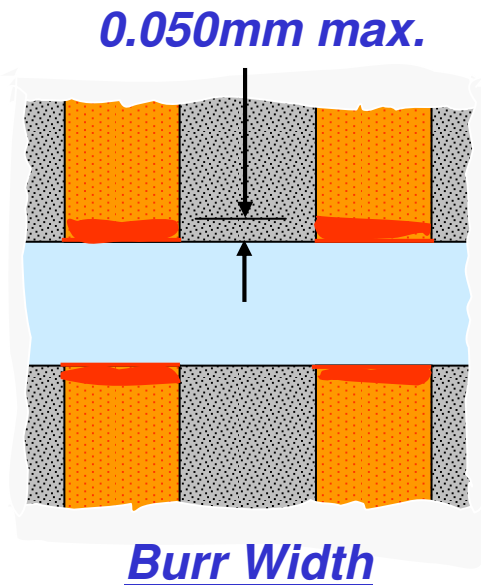
**Burr & Smearing
Geometry**

Copper Smearing

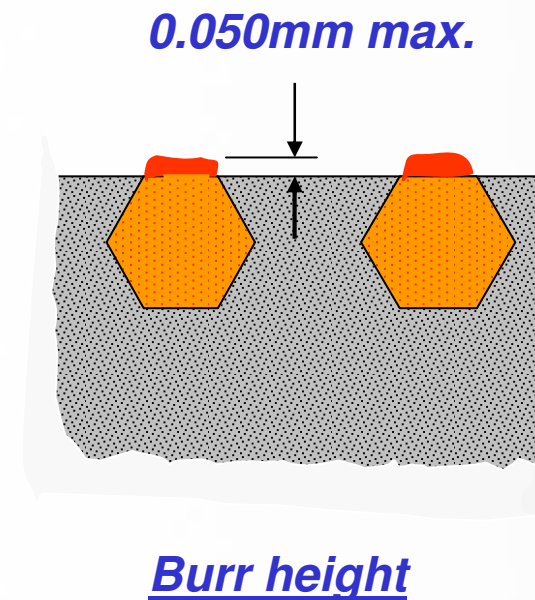


Cross Section

QFN Singulation



Top view



Cross section

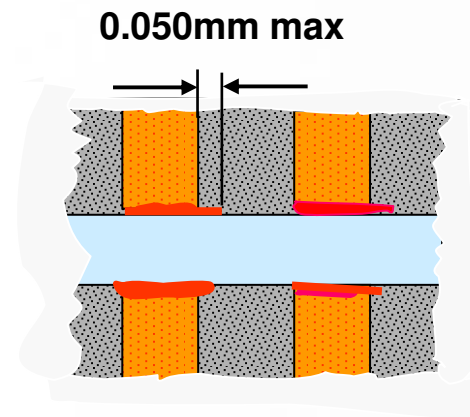
- ❖ *Specification limits may vary between end-users*

Burrs Specification

QFN Singulation

- X- Burr - 0.050mm max.

- No Lead Delaminating.
- No Lead Removal.



Top view

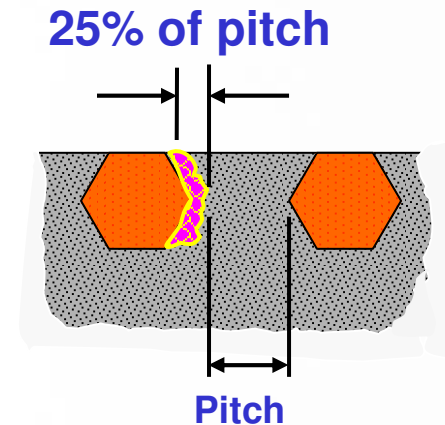
- *Specification limits may vary between end-users*

X - Burrs Specification

QFN Singulation

General Rules

- Smearing < 25 % of lead pitch
- No lead de-lamination
- No lead removal



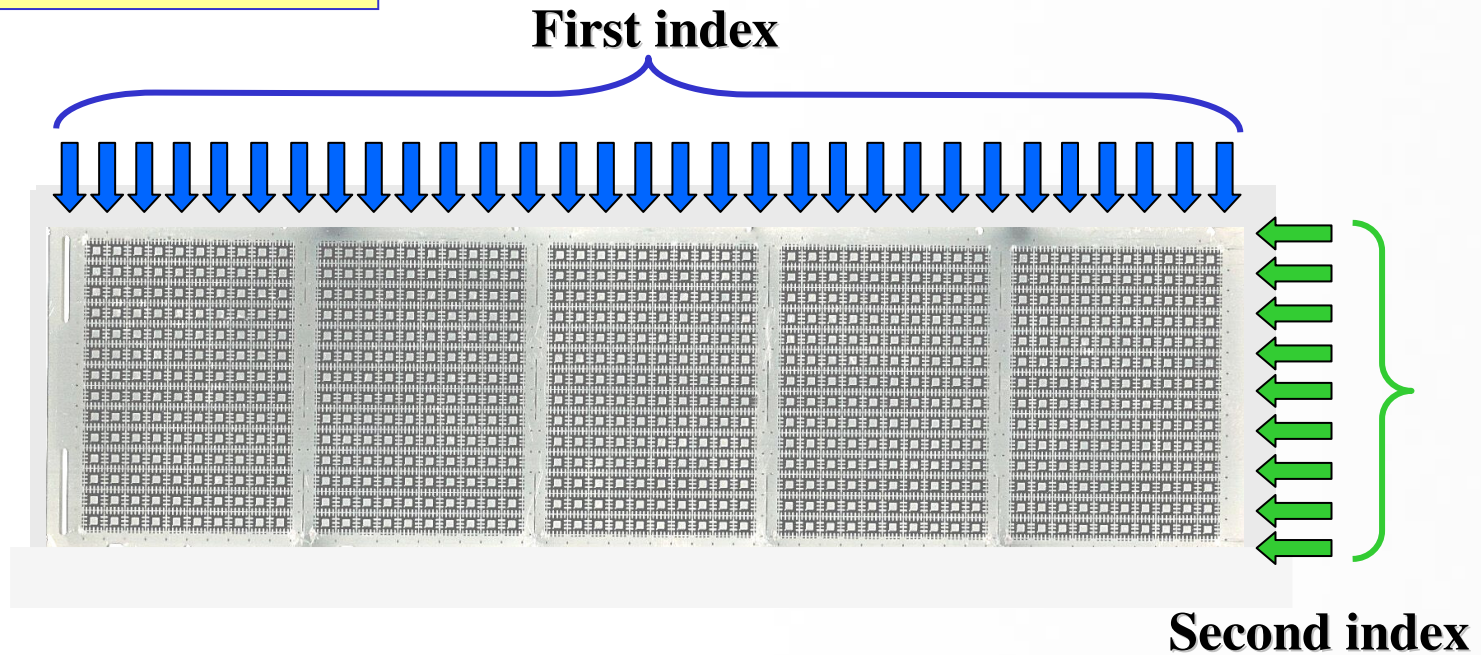
Cross section

- ❖ *Specification limits may vary between end-users*

Smearing Specification

QFN Singulation

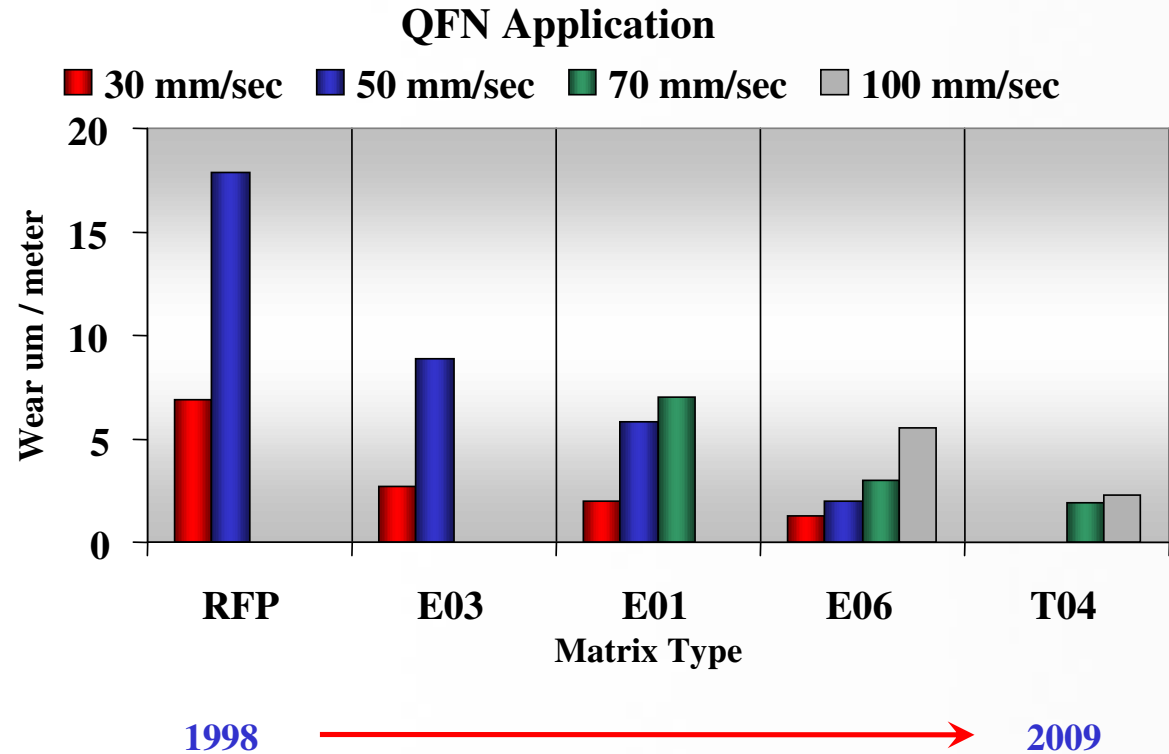
Tape process:



Dicing sequence to minimize load

"E" & "T" Types Resin Blades for QFN

- Best Cost of Ownership
- Better blade life (Exceeding 1000 m)
- Above average cut quality
- Better throughput



Cost Reduction Success Story: R → E → T Series for QFN Applications